NTB65N02R, NTP65N02R

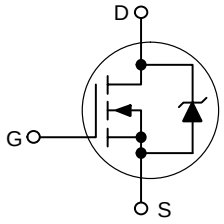
Product Preview

Power MOSFET
65 A, 24 V N-Channel
TO-220, D²PAK

ON Semiconductor®

http://onsemi.com

65 A, 24 V
$R_{DS(on)}$ = 8.3 mΩ (TYP)



Features

- Planar HD3e Process for Fast Switching Performance
- Low R_{DSon} to Minimize Conduction Loss
- Low C_{iss} to Minimize Driver Loss
- Low Gate Charge
- Fast Switching

MAXIMUM RATINGS (T_J = 25°C Unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain–to–Source Voltage	V_{DSS}	24	V_{dc}
Gate–to–Source Voltage Continuous	V_{GS}	±20	V_{dc}
Drain Current (Continuous @ T_A = 25°C (Note 3) Single Pulse (tp = 10 μs)	I_D I_{DM}	65 160	A A
Total Power Dissipation @ T_A = 25°C	P_D	78	W
Operating and Storage Temperature	T_J and T_{stg}	–55 to 150	°C
Single Pulse Drain–to Source Avalanche Energy – Starting T_J=25°C (V_{DD} = 50 V_{dc}, V_{GS} = 5 V_{dc}, I_L = A_{pk}, L = 1 mH, R_G = 25 Ω)	E_{AS}	TBD	mJ
Thermal Resistance Junction–to–Case Junction–to–Ambient (Note 1) Junction–to–Ambient (Note 2)	$R_{\theta JC}$ $R_{\theta JA}$ $R_{\theta JA}$	1.6 67 120	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from Case for 10 Seconds	T_L	260	°C

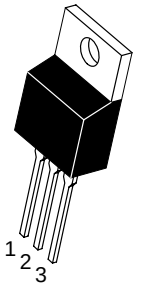
1. When surface mounted to an FR4 board using 1 inch pad size, (Cu Area 1.127 in^2).
2. When surface mounted to an FR4 board using minimum recommended pad size, (Cu Area 0.412 in^2).
3. Chip current capability limited by package.

PIN ASSIGNMENT

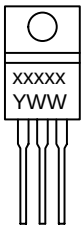
PIN	FUNCTION
1	Gate
2	Drain
3	Source
4	Drain

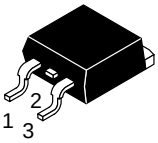
This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

MARKING DIAGRAMS

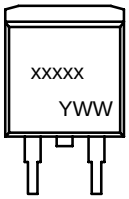


TO–220AB
CASE 221A
Style 5





D²PAK
CASE 418B
Style 2



xxxxx = Specific Device Code
Y = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NTB65N02R	D²PAK	50 Units/Rail
NTB65N02RT4	D²PAK	800 Tape & Reel
NTP65N02R	TO–220AB	50 Units/Rail

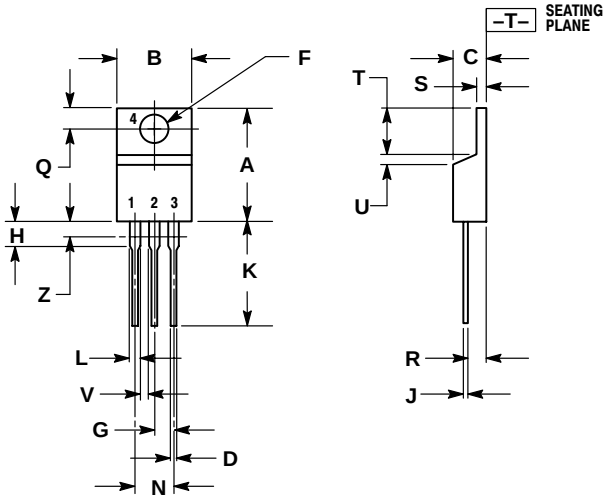
ELECTRICAL CHARACTERISTICS (T_J = 25°C Unless otherwise specified)

Characteristics	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain–to–Source Breakdown Voltage (Note 4) (V_{GS} = 0 V_{dc}, I_D = 250 μA_{dc}) Temperature Coefficient (Positive)	$V(br)_{DSS}$	 24 –	 27.5 25.5	 – –	V_{dc} mV/°C
Zero Gate Voltage Drain Current (V_{DS} = 20 V_{dc}, V_{GS} = 0 V_{dc}) (V_{DS} = 20 V_{dc}, V_{GS} = 0 V_{dc}, T_J = 150°C)	I_{DSS}	 – –	 – –	 1.5 15	μA_{dc}
Gate–Body Leakage Current (V_{GS} = ±20 V_{dc}, V_{DS} = 0 V_{dc})	I_{GSS}	 –	 –	 ±100	nA_{dc}
ON CHARACTERISTICS (Note 4)					
Gate Threshold Voltage (Note 4) (V_{DS} = V_{GS}, I_D = 250 μA_{dc}) Threshold Temperature Coefficient (Negative)	V_{GS}(th)	 1.0 –	 1.5 –4.1	 2.0 –	V_{dc} mV/°C
Static Drain–to–Source On–Resistance (Note 4) (V_{GS} = 4.5 V_{dc}, I_D = 15 A_{dc}) (V_{GS} = 10 V_{dc}, I_D = 20 A_{dc}) (V_{GS} = 10 V_{dc}, I_D = 30 A_{dc})	R_{DS}(on)	 – – –	 10.5 8.3 9.5	 12.5 10.5 –	mΩ
Forward Transconductance (Note 4) (V_{DS} = 10 V_{dc}, I_D = 15 A_{dc})	g_{FS}	 –	 20	 –	Mhos
DYNAMIC CHARACTERISTICS					
Input Capacitance	(V_{DS} = 24 V_{dc}, V_{GS} = 0 V f = 1 MHz)	C_{iss}	–	1050	1470	pF
Output Capacitance		C_{oss}	–	394	550	
Transfer Capacitance		C_{rss}	–	88	120	
SWITCHING CHARACTERISTICS (Note 5)					
Turn–On Delay Time	(V_{GS} = 5 V_{dc}, V_{DD} = 10 V_{dc}, I_D = 30 A_{dc}, R_G = 3 Ω)	t_d(on)	–	11.2	20	ns
Rise Time		t_r	–	52	100	
Turn–Off Delay Time		t_d(off)	–	10	20	
Fall Time		tf	–	4	10	
Gate Charge	(V_{GS} = 4.5 V_{dc}, I_D = 30 A_{dc}, V_{DS} = 10 V_{dc}) (Note 4)	Q_T	–	8.4	12	nC
		Q_1	–	3.7	–	
		Q_2	–	4.04	–	
SOURCE–DRAIN DIODE CHARACTERISTICS					
Forward On–Voltage	(I_S = 20 A_{dc}, V_{GS} = 0 V_{dc}) (Note 4) (I_S = 30 A_{dc}, V_{GS} = 0 V_{dc}) (I_S = 20 A_{dc}, V_{GS} = 0 V_{dc}, T_J = 125°C)	V_{SD}	– – –	0.88 1.10 0.80	1.2 – –	V_{dc}
Reverse Recovery Time	(I_S = 20 A_{dc}, V_{GS} = 0 V_{dc}, dI_S/dt = 100 A/μs) (Note 4)	t_{rr}	–	15.5	–	ns
		t_a	–	12.6	–	
		t_b	–	2.6	–	
Reverse Recovery Stored Charge		Q_{RR}	–	0.005	–	μC

4. Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%.
5. Switching characteristics are independent of operating junction temperatures.

PACKAGE DIMENSIONS

TO–220AB
CASE 221A–09
ISSUE AA

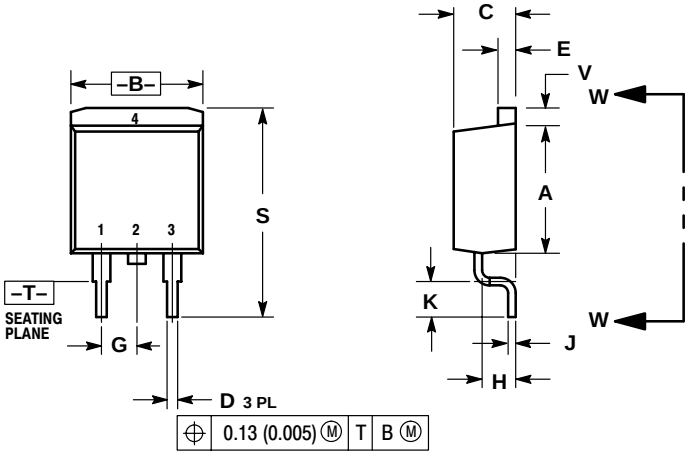


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 5:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

D^2PAK
CASE 418B–04
ISSUE G



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 418B–01 THRU 418B–03 OBSOLETE, NEW STANDARD 418B–04.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
M	0.280	0.320	7.11	8.13
N	0.197 REF		5.00 REF	
P	0.079 REF		2.00 REF	
R	0.039 REF		0.99 REF	
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

STYLE 2:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

PUBLICATION ORDERING INFORMATION

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